Development of Vapor Explosion Promotor for Rapid Cooling and Atomizing of High Melting Point Metal

Background

Amorphous materials have functional characteristics such as electro-magnetic property and corrosion resistance. The material compositions to be amorphized are, however, limited due to low cooling rate of conventional liquid atomizing methods. Therefore, we have proposed the ultra rapid cooling and atomization technique using sustainable small-scale vapor explosion, namely CANOPUS * ¹. Cooling rate of the CANOPUS method is more than 280 times as high as that of the conventional liquid atomizing methods. Vapor explosion can occur below a certain molten material temperature. The upper-limit temperature of the molten material, in which vapor explosion can occur, differs from one coolant to another. In order to amorphize high melting-point materials, it is necessary to develop a vapor explosion promotor that induces vapor explosion in high-temperature molten materials.

Objectives

To develop a vapor explosion promotor that induces vapor explosion in high-temperature molten materials and to clarify the promotion mechanism of vapor explosion,

Principal Results

1. Development of vapor explosion promotor

A molten tin droplet was released from a nozzle into a coolant pool to investigate the temperature range of molten tin where vapor explosion occurred. When a salt is dissolved into water, the upper-limit temperature shifts to the higher temperature (Fig.1). The highest temperature shift was achieved for a lithium chloride aqueous solution among other solutions, as the vapor explosions were observed over 1000°C in the lithium chloride aqueous solution. The lithium chloride aqueous solution is, therefore the most efficient vapor explosion promoter within the test solutions.

2. Evaluation of vapor film collapse process

In order to investigate the effect of salt additives on the shifts of upper-limit temperature, a high-temperature stainless-steel sphere was immersed into a coolant pool. The acquired temperature at the vapor film collapse in salt water is higher than that in water (Fig.2). In addition, measured time traces of the temperature signals indicate that film boiling heat transfer is increased for the salt additives into water, which may cause a shift of upper-limit temperature of the vapor explosion (Fig.3).

3. Clarification of mechanism which promotes vapor explosion

The temperature of vapor film collapse roughly agrees with the upper-limit temperature of vapor explosion region into the same solution (Fig.4). Therefore, salt additives into water induce the collapse of vapor film at high temperature, which results in the triggering of vapor explosions.

Future Developments

The developed vapor explosion promotors will be applied on the basis of the CANOPUS method for producing new functional amorphous powders.

Main Researchers:

Takahiro Arai, Researcher, Nuclear Power Generation Technology Sector, Nuclear Technology Research Laboratory Masahiro Furuya, Ph. D., Senior Researcher, Nuclear Power Generation Technology Sector, Nuclear Technology Research Laboratory

Reference

T. Arai, et.al., 2006, "Development of Vapor Explosion Promotor for Rapid Cooling and Atomizing of High Melting Point Metal", CRIEPI Report, L05013 (in Japanese)

*1: CANOPUS is an abbreviation of Cooling and Atomizing based on <u>NO</u>ble Process <u>Utilizing Steam</u> explosion.

Molten tin te	emperatur	e: 500°C					Table 1 Upper-	limit temperature of
Coolant	0.00 s	0.03 s	0.07 s	0.10 s	0.13 s	 Solution 	vapor explosion	
Water (80°C)		∱ Molten tin		2	-	surface <u>↓</u> 10mm	Coolant (80 °C) (20wt% solution)	Upper-limit temperature of vapor explosion (°C)
	Coolant	19	19	8	10 AN		Water	No explosion
20wt% Sodium chloride solution (80°C)				and the second second		 Solution 	MgSO ₄ solution	425
	Coolant	Molten tin				surface 10mm	NaCl solution	550
							MgCl ₂ solution	650
							$CaCl_2$ solution	730

Triggering of vapor explosion



vapor onprotion					
Coolant (80 °C) (20wt% solution)	Upper-limit temperature of vapor explosion (°C)				
Water	No explosion				
MgSO ₄ solution	425				
NaCl solution	550				
MgCl ₂ solution	650				
CaCl ₂ solution	730				
LiCI solution	1190				



Fig.2 Effect of salt additives on vapor film collapse





Fig.4 Relationship of upper-limit temperature of vapor explosion to vapor film collapse temperature